Preferred Device

Sensitive Gate Triacs

Silicon Bidirectional Thyristors

Designed primarily for full-wave AC control applications, such as light dimmers, motor controls, heating controls and power supplies; or wherever full-wave silicon gate controlled solid-state devices are needed. Triac type thyristors switch from a blocking to a conducting state for either polarity of applied anode voltage with positive or negative gate triggering.

Features

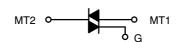
- Sensitive Gate Triggering Uniquely Compatible for Direct Coupling to TTL, HTL, CMOS and Operational Amplifier Integrated Circuit Logic Functions
- Gate Triggering: 4 Mode 2N6071A, B; 2N6073A, B; 2N6075A, B
- Blocking Voltages to 600 V
- All Diffused and Glass Passivated Junctions for Greater Parameter Uniformity and Stability
- Small, Rugged, Thermopad Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Device Marking: Device Type, e.g., 2N6071A, Date Code



ON Semiconductor®

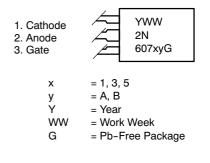
http://onsemi.com

TRIACS 4.0 A RMS, 200 - 600 V





MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Rating	Symbol	Value	Unit
*Peak Repetitive Off-State Voltage (Note 1) (T _J = -40 to 110°C, Sine Wave, 50 to 60 Hz, Gate Open) 2N6071A,B 2N6073A,B 2N6075A,B	V _{DRM,} V _{RRM}	200 400 600	V
*On-State RMS Current (T _C = 85°C) Full Cycle Sine Wave 50 to 60 Hz	I _{T(RMS)}	4.0	А
*Peak Non-repetitive Surge Current (One Full cycle, 60 Hz, T_J = +110°C)	I _{TSM}	30	А
Circuit Fusing Considerations (t = 8.3 ms)	l ² t	3.7	A ² s
*Peak Gate Power (Pulse Width \leq 1.0 $\mu s,T_C$ = 85°C)	P _{GM}	10	W
*Average Gate Power (t = 8.3 ms, T_C = 85°C)	P _{G(AV)}	0.5	W
*Peak Gate Voltage (Pulse Width \leq 1.0 $\mu s,~T_C$ = 85°C)	V _{GM}	5.0	V
*Operating Junction Temperature Range	TJ	-40 to +110	°C
*Storage Temperature Range	T _{stg}	-40 to +150	°C
Mounting Torque (6-32 Screw) (Note 2)	-	8.0	in. lb.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Torque rating applies with use of a compression washer. Mounting torque in excess of 6 in. lb. does not appreciably lower case-to-sink thermal resistance. Main terminal 2 and heatsink contact pad are common.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
*Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	3.5	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	75	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	ΤL	260	°C

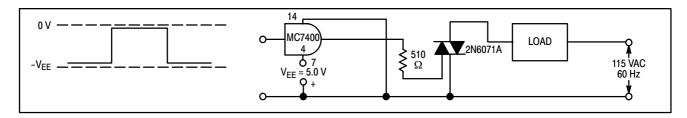
*Indicates JEDEC Registered Data.

Characteristic		Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
	= 25°C = 110°C	I _{DRM,} I _{RRM}			10 2	μA mA
DN CHARACTERISTICS						
*Peak On-State Voltage (Note 3) ($I_{TM} = \pm 6.0 \text{ A Peak}$)		V _{TM}	-	-	2	V
*Gate Trigger Voltage (Continuous DC), All Quadrants (Main Terminal Voltage = 12 Vdc, R_L = 100 Ω , T_J = -40°C)		V _{GT}	-	1.4	2.5	V
Gate Non-Trigger Voltage, All Quadrants (Main Terminal Voltage = 12 Vdc, $R_L = 100 \Omega$, $T_J = 110^{\circ}C$)			0.2	-	_	V
	±1 Adc) = -40°C = 25°C	ι _Η			30 15	mA
Turn-On Time (I _{TM} = 14 Adc, I _{GT} = 100 mAdc)		t _{gt}	-	1.5	-	μs
		Ť	(QUAD (Maximu)
	Туре	I _{GT} @ T _J	l mA	ll mA	III mA	IV mA
Gate Trigger Current (Continuous DC)	2N6071A	+25°C	5	5	5	10
(Main Terminal Voltage = 12 Vdc, R_L = 100 Ω)	2N6073A 2N6075A	-40°C	20	20	20	30
	2N6071B 2N6073B	+25°C	3	3	3	5
	2N6073B 2N6075B	-40°C	15	15	15	20
	-					
DYNAMIC CHARACTERISTICS				1	1	
 PYNAMIC CHARACTERISTICS Critical Rate of Rise of Commutation Voltage @ V_{DRM}, T_J = 85°C, Gate Open, I_{TM} = 5.7 A, Exponential Wave Commutating di/dt = 2.0 A/ms 	form,	dv/dt(c)	-	5	-	V/ļ

3. Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%.

*Indicates JEDEC Registered Data.

SAMPLE APPLICATION: TTL-SENSITIVE GATE 4 AMPERE TRIAC TRIGGERS IN MODES II AND III



Trigger devices are recommended for gating on Triacs. They provide:

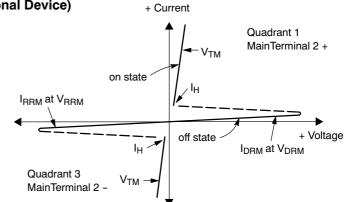
1. Consistent predictable turn-on points.

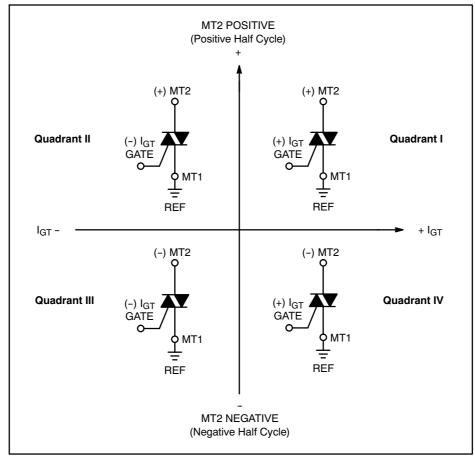
2. Simplified circuitry.

3. Fast turn-on time for cooler, more efficient and reliable operation.

Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter
V _{DRM}	Peak Repetitive Forward Off State Voltage
I _{DRM}	Peak Forward Blocking Current
V _{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V _{TM}	Maximum On State Voltage
Ι _Η	Holding Current





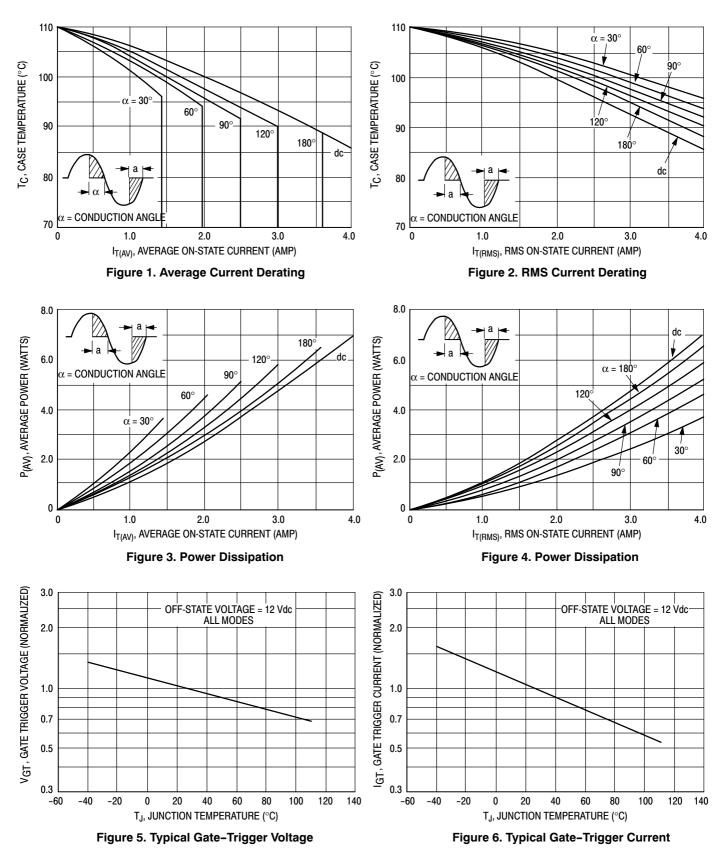
Quadrant Definitions for a Triac

All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used.

SENSITIVE G	GATE LOGIC	REFERENCE
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IC Logic Functions	Firing Quadrant				
IC LOGIC Functions	I	II	Ш	IV	
TTL		2N6071A Series	2N6071A Series		
HTL		2N6071A Series	2N6071A Series		
CMOS (NAND)	2N6071B Series			2N6071B Series	
CMOS (Buffer)		2N6071B Series	2N6071B Series		
Operational Amplifier	2N6071A Series			2N6071A Series	
Zero Voltage Switch		2N6071A Series	2N6071A Series		



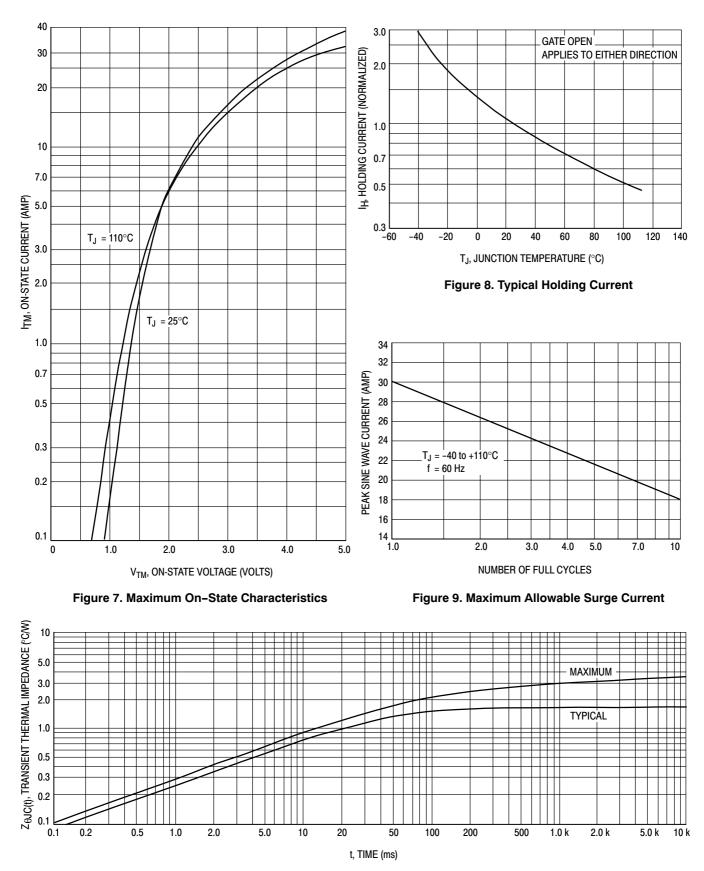


Figure 10. Thermal Response

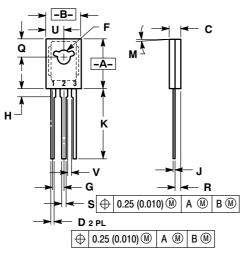
ORDERING INFORMATION

Device	Package	Shipping [†]	
2N6071A	TO-225		
2N6071AG	TO-225 (Pb-Free)	500 Units / Box	
2N6071AT	TO-225	50 Units / Tube 2000 Units / Box	
2N6071ATG	TO-225 (Pb-Free)	50 Units / Tube 2000 Units / Box	
2N6071B	TO-225		
2N6071BG	TO-225 (Pb-Free)	500 Units / Box	
2N6071BT	TO-225	50 Units / Tube 2000 Units / Box	
2N6071BTG	TO-225 (Pb-Free)	50 Units / Tube 2000 Units / Box	
2N6073A	TO-225		
2N6073AG	TO-225 (Pb-Free)		
2N6073B	TO-225		
2N6073BG	TO-225 (Pb-Free)		
2N6075A	TO-225	500 Units / Box	
2N6075AG	TO-225 (Pb-Free)		
2N6075B	TO-225	7	
2N6075BG	TO-225 (Pb-Free)	1	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

TO-225 CASE 77-09 ISSUE Z



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

 CONTROLLING DIMENSION: INCH.
 077-01 THRU -08 OBSOLETE, NEW STANDARD 077-09.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.425	0.435	10.80	11.04
В	0.295	0.305	7.50	7.74
С	0.095	0.105	2.42	2.66
D	0.020	0.026	0.51	0.66
F	0.115	0.130	2.93	3.30
G	0.094	BSC	2.39	BSC
Н	0.050	0.095	1.27	2.41
J	0.015	0.025	0.39	0.63
K	0.575	0.655	14.61	16.63
М	5° TYP		5° TYP	
Q	0.148	0.158	3.76	4.01
R	0.045	0.065	1.15	1.65
S	0.025	0.035	0.64	0.88
U	0.145	0.155	3.69	3.93
V	0.040		1.02	

STYLE 5: PIN 1. MT 1 2. MT 2 3. GATE

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